

DESCRIPTION

ZD1117 is a series of low dropout three-terminal regulators with a dropout of 1.3V at 1A load current. ZD1117 features a low standby current 2mA.

Other than a fixed version ($V_{out} = 1.2V, 1.5V, 1.8V, 2.5V, 3.3V, 5V, \text{ and } 12V$), ZD1117 has an adjustable version, which can provide an output voltage from 1.25 to 12V with only two external resistors.

ZD1117 offers thermal shut down and current limit functions, to assure stability of chip and power system. Trimming technique is used to guarantee output voltage accuracy within $\pm 2\%$. Other output voltage accuracy such as $\pm 1\%$ can be customized on demand.

ZD1117 is available in SOT-223, TO-252 power packages.

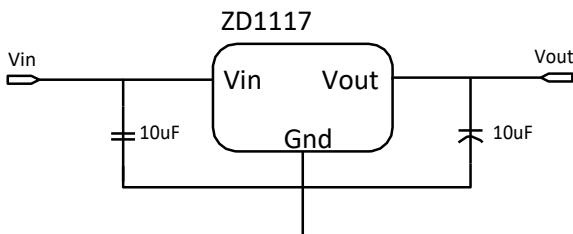
FEATURES

- Other than a fixed version and an adjustable version, output value can be customized on demand.
- Maximum output current is 1A
- Range of operation input voltage: Max 18V
- Standby current: 2mA (typ.)
- Line regulation: 0.1%/V (typ.)
- Load regulation: 10mV (typ.)
- Environment Temperature: -40°C~85°C
- Compatible with tantalum capacitor, electrolytic capacitor and MLCC.

APPLICATIONS

- Power Management for Computer Mother Board, Graphic Card
- LCD Monitor and LCD TV
- DVD Decode Board
- ADSL Modem
- Post Regulators for Switching Supplies

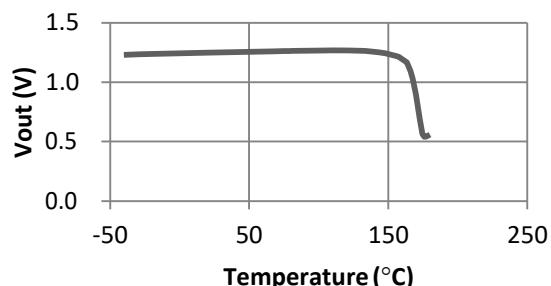
TYPICAL APPLICATION



Application circuit ZD1117 fixed version

TYPICAL ELECTRICAL CHARACTERISTIC

ZD1117-ADJ V_{out} Vs. Temp

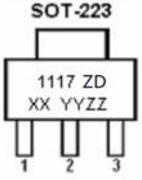
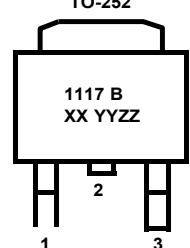


ORDERING INFORMATION

ZD1117 ①②③④⑤

Code	Description
①	Temperature&Rohs: I:-40~85°C ,Pb Free Rohs Std.
②	Package type: L:SOT-223 O:TO-252
③	Packing type: TR:Tape&Reel(Standard)
④	Output voltage: e.g. 12=1.2V 15=1.5V 18=1.8V 25=2.5V 33=3.3V 50=5.0V 120=12V AD=Output adjustable
⑤	Voltage accuracy: 1=±1%(Customized) Blank(default)=±2%

PIN CONFIGURATION

Product Classification	ZD1117ILTR④
Marking	SOT-223  1117 ZD XX YYZZ 1 Vss/ADJ 2 Vout 3 Vin
Product Classification	LC1117IOTR④
Marking	TO-252  1117 B XX YYZZ 1 Vss/ADJ 2 Vout 3 Vin
Vss/Adj	Ground Pin/Adjustable
Vin	Supply Voltage Input
Vout	Output Voltage

ABSOLUTE MAXIMUM RATING

Parameter	Value
Max Input Voltage	18V ^(*)
Max Operating Junction Temperature(Tj)	150°C
Ambient Temperature(Ta)	-40°C – 85°C
Package Thermal Resistance(θ_{jc})	20°C / W
	12.5°C / W
Storage Temperature(Ts)	-40°C - 150°C
Lead Temperature & Time	260°C, 10S

Note: Exceed these limits to damage to the device. Exposure to absolute maximum rating conditions may affect device reliability.

RECOMMENDED WORK CONDITIONS

Parameter	Value
Input Voltage Range	Max. 16V ^(*)
Operating Junction Temperature(Tj)	-40°C–125°C

^(*)Exceptional for ZD1117-12V, the maximum input voltage for ZD1117-12V is 20V.

ELECTRICAL CHARACTERISTICS

 $T_j=25^\circ\text{C}$

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Vref	Reference Voltage	ZD1117-ADJ 10mA \leq Iout \leq 1A , Vin=3.25V	1.225	1.25	1.275	V
Vout	Output Voltage	ZD1117-1.2V 0 \leq Iout \leq 1A , Vin=3.2V	1.176	1.2	1.224	V
		ZD1117-1.5V 0 \leq Iout \leq 1A , Vin=3.5V	1.47	1.5	1.53	V
		ZD1117-1.8V 0 \leq Iout \leq 1A , Vin=3.8V	1.764	1.8	1.836	V
		ZD1117-2.5V 0 \leq Iout \leq 1A , Vin=4.5V	2.45	2.5	2.55	V
		ZD1117-3.3V 0 \leq Iout \leq 1A , Vin=5.3V	3.234	3.3	3.366	V
		ZD1117-5.0V 0 \leq Iout \leq 1A , Vin=7.0V	4.9	5	5.1	V
		ZD1117-12.0V 0 \leq Iout \leq 1A , Vin=14V	11.76	12	12.24	V
		ZD1117-1.2V Iout=10mA, 2.7V \leq Vin \leq 15V		0.1	0.2	%/V
ΔV_{out}	Line Regulation	ZD1117-ADJ Iout=10mA, 2.75V \leq Vin \leq 16V		0.1	0.2	%/V
		ZD1117-1.5V Iout=10mA, 3.0V \leq Vin \leq 16V		0.1	0.2	%/V
		ZD1117-1.8V Iout=10mA, 3.3V \leq Vin \leq 16V		0.1	0.2	%/V
		ZD1117-2.5V Iout=10mA, 4.0V \leq Vin \leq 16V		0.1	0.2	%/V
		ZD1117-3.3V Iout=10mA, 4.8V \leq Vin \leq 16V		0.1	0.2	%/V
		ZD1117-5.0V Iout=10mA, 6.5V \leq Vin \leq 16V		0.1	0.2	%/V
		ZD1117-12.0V Iout=10mA, 13.5V \leq Vin \leq 20V		0.1	0.2	%/V
ΔV_{out}	Load Regulation	ZD1117-ADJ Vin =2.7V, 10mA \leq Iout \leq 1A		10	30	mV
		ZD1117-ADJ Vin =2.75V, 10mA \leq Iout \leq 1A		10	30	mV
		ZD1117-1.5V Vin=3.0V, 10mA \leq Iout \leq 1A		10	30	mV
		ZD1117-1.8V Vin=3.3V, 10mA \leq Iout \leq 1A		10	30	mV
		ZD1117-2.5V Vin=4.0V, 10mA \leq Iout \leq 1A		10	30	mV
		ZD1117-3.3V Vin=4.8V, 10mA \leq Iout \leq 1A		10	30	mV
		ZD1117-5.0V Vin=6.5V, 10mA \leq Iout \leq 1A		10	30	mV
		ZD1117-12.0V Vin=13.5V, 10mA \leq Iout \leq 1A		10	30	mV

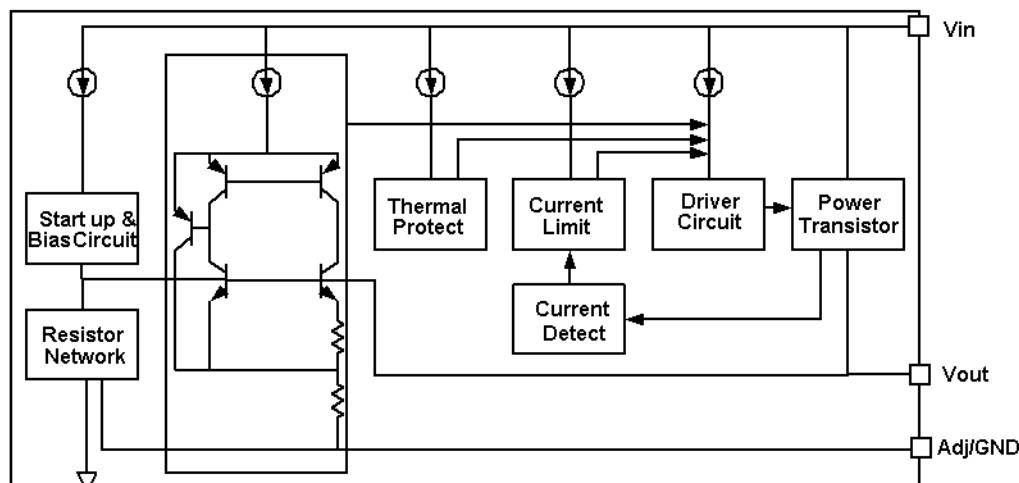
ELECTRICAL CHARACTERISTICS continued

 $T_j=25^\circ\text{C}$

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Vdrop	Dropout Voltage	Iout=100mA		1.23	1.3	V
		Iout=1A		1.3	1.5	V
Ilimit	Current Limit	Vin-Vout=2V, $T_j=25^\circ\text{C}$	1			A
Imin	Minimum Load Current	ZD1117-ADJ		2	10	mA
Iq	Quiescent Current	ZD1117-1.2V, Vin =10V		2	5	mA
		ZD1117-1.5V, Vin =12V		2	5	mA
		ZD1117-1.8V, Vin =12V		2	5	mA
		ZD1117-2.5V, Vin =12V		2	5	mA
		ZD1117-3.3V, Vin =12V		2	5	mA
		ZD1117-5.0V, Vin =12V		2	5	mA
		ZD1117-12.0V, Vin =20V		2	5	mA
IAdj	Adjust Pin Current	ZD1117-ADJ Vin =5V, 10mA≤Iout≤1A		55	120	uA
Ichange	Iadj change	ZD1117-ADJ Vin =5V, 10mA≤Iout≤1A		0.2	10	uA
ΔV/ΔT	Temperature coefficient			±100		ppm
θ _{JC}	Thermal Resistance	SOT-223		20		°C/W
		TO-252		10		
		TO-220		4.5		

Note1: All test are conducted under ambient temperature 25°C and within a short period of time 20ms**Note2:** Load current smaller than minimum load current of ZD1117-ADJ will lead to unstable or oscillation output.

BLOCK DIAGRAM



DETAILED DESCRIPTION

ZD1117 is a series of low dropout voltage, three terminal regulators. Its application circuit is very simple: the fixed version only needs two capacitors and the adjustable version only needs two resistors and two capacitors to work. It is composed of some modules including start-up circuit, bias circuit, bandgap, thermal shutdown, current limit, power transistors and its driver circuit and so on.

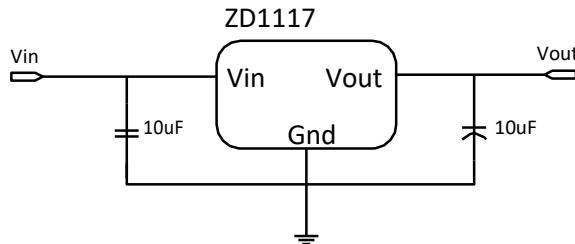
The thermal shut down modules can assure chip and its application system working safety when the junction temperature is larger than 140°C.

The bandgap module provides stable reference voltage, whose temperature coefficient is compensated by careful design considerations. The temperature coefficient is under 100 ppm/°C. And the accuracy of output voltage is guaranteed by trimming technique.

TYPICAL APPLICATION

ZD1117 has an adjustable version and six fixed versions (1.2V, 1.5V, 1.8V, 2.5V, 3.3V, 5V and 12V)

Fixed Output Voltage Version

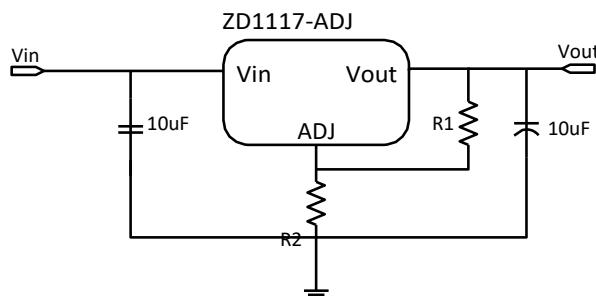


Application circuit of ZD1117 fixed version

- 1) Recommend using 10uF tan capacitor as bypass capacitor (C1) for all application circuit.
- 2) Recommend using 10uF tan capacitor to assure circuit stability.

Adjustable Output Voltage Version

ZD1117-ADJ provides a 1.25V reference voltage. Any output voltage between 1.25V~12V can be achievable by choosing two external resistors (schematic is shown below), R1 and R2



Application Circuit of ZD1117-ADJ

The output voltage of adjustable version follows the equation: $V_{out} = 1.25 \times (1 + R2/R1) + I_{Adj} \times R2$. We can ignore I_{Adj} because I_{Adj} (about 50uA) is much less than the current of R1 (about 2~10mA).

ZD1117

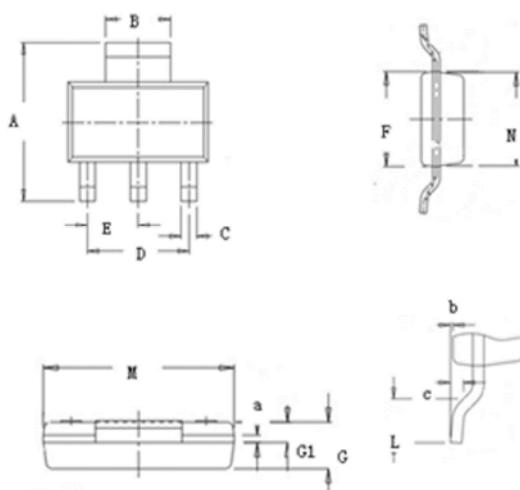
- 1) To meet the minimum load current ($>10mA$) requirement, $R1$ is recommended to be 125Ω or lower. As ZD1117-ADJ can keep itself stable at load current about $2mA$, $R1$ is not allowed to be higher than 625Ω .
- 2) Using a bypass capacitor (C_{ADJ}) between the ADJ pin and ground can improve ripple rejection. This bypass capacitor prevents ripple from being amplified as the output voltage is increased. The impedance of C_{ADJ} should be less than $R1$ to prevent ripple from being amplified. As $R1$ is normally in the range of $100\Omega \sim 500\Omega$, the value of C_{ADJ} should satisfy this equation: $1/(2\pi \times f_{ripple} \times C_{ADJ}) < R1$.

Thermal Considerations

We have to take heat dissipation into great consideration when output current or differential voltage of input and output voltage is large. Because in such cases, the power dissipation consumed by ZD1117 is very large. ZD1117 series uses SOT-223 package type and its thermal resistance is about $20^\circ\text{C}/\text{W}$. And the copper area of application board can affect the total thermal resistance. If copper area is $5\text{cm} \times 5\text{cm}$ (two sides), the resistance is about $30^\circ\text{C}/\text{W}$. So the total thermal resistance is about $20^\circ\text{C}/\text{W} + 30^\circ\text{C}/\text{W}$. We can decrease total thermal resistance by increasing copper area in application board. When there is no good heat dissipation copper are in PCB, the total thermal resistance will be as high as $120^\circ\text{C}/\text{W}$, then the power dissipation of ZD1117 could allow on itself is less than 1W . And furthermore, ZD1117 will work at junction temperature higher than 125°C under such condition and no lifetime is guaranteed.

PACKAGE OUTLINE

SOT-232



COMMON DIMENSIONS

SYMBOL	MILLIMETER		
	MIN	MM	MAX
A	6.85	6.95	7.05
B	2.85	2.95	3.05
C	0.65	0.71	0.81
D	4.60		
E	2.25	2.30	2.35
F	3.45	3.50	3.55
G	1.55	1.60	1.65
G1	0.675	0.700	0.725
L	0.9	1.0	1.1
N	3.40	3.45	3.50
M	6.45	6.5	6.6
a	0.229	0.254	0.279
b	0.02	0.06	0.100
c		0.3	

TO-252:

TO-252 PACKAGE OUTLINE DIMENSIONS

